

### Surface-mount Ceramic Multilayer Capacitors (RoHS compliant & Halogen Free)

CC0201KRX7R8BB103

(0201 ,X7R, 10nF, 25V, ±10%)

Spec Sheet

### Scope

This product specification is applied to Multi-layer Ceramic Capacitor used for General Electronic equiments.

## Yageo Part Number

L2

Lз



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L2/L3

0.3±0.03

0.10 to 0.20

(2) Capacitance Tolerance:	±10%
(4) Temperature Characteristics:	X7R
Temperature Range:	-55 to 125 °C
Cap Change:	±15%
(5) Rated Voltage:	25V
(6) Capacitance:	10nF
(3) Package:	Paper Tape Reel 7"
Packaging Unit:	15,000 pcs
Resistance:	10 GΩ
Dielectric Loss Tangent:	5%
RoHS Compliance:	Yes
Halogen Free:	Yes
Soldering Method:	Reflow



#### IEC-60384 Standard Specification and Test methods

Test Item	Procedure	Requirements
Mounting	The capacitors may be mounted on printed-circuit boards or	No visible damage
	ceramic substrates.	
Visual inspection and	Any applicable method using x10 magnification	In accordance with specification
dimension check		
Capacitance	Class1 :	Within specified tolerance
	C ≤1nF, f = 1 MHz;	
Dielectric loss tangent	C > 1nF, f = 1 KHz;	
	NPO: measuring voltage 1 V at room temp.	
	Class 2 (X5R, X6S, X7R, Y5V) :	
	Precondition:	
	150 +0/-10 $^\circ\mathrm{C}/1$ hr , then keep for 24±1 hrs at room temp.	
	f = 1 KHz; measuring voltage 1 V at $20^{\circ}$ C	
Insulation resistance	At Ur (DC) for 1 minute	In accordance with specification
	Ur(DC) > 500V: At 500V for 1 minute	
Temperature coefficient	Capacitance shall be measured by the steps shown in the	Class I:
	following table.	$\Delta$ C/C: ±30ppm
	The capacitance change should be measured after 5 min at	
	each specified temperature stage.	Class II:
	Step Temperature	X7R/ X5R: ∆ C/C: ±15%
	a 25±2	Y5V: ∆ C/C: +22~-82%
	b Lower Temperature ±3	
	c 25±2	
	d Upper Temperature ±2	
	e 25±2	
	(1) Class I	
	Temperature Coefficient shall be calculated from the formula	
	as below:	
	Temp, Coefficient = $\frac{C2 - C1}{C1 \times \triangle T} \times 10^6$ [ppm/C]	
	C1: Capacitance at step c	
	C2: Capacitance at 125°C	
	∆T: 100°C (=125°C -25°C )	
	(2) Class II	
	Capacitance Change shall be calculated from the formula	
	as below.	
	$\triangle C = \frac{C2 - C1}{C1} \times 100(\%)$	
	C1: Capacitance at step c	
	C2: Capacitance at step b or d	



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Adhesion	A force applied for 10 sec to the line joining the terminations	Force:
	and in a plane parallel to the substrate.	size $\geq$ 0603: $\geq$ 5N, size=0402: $\geq$ 2.5N, size<0201: $\geq$ 1N
Bending Strength	Mounting in accordance with IEC 60384-22 paragraph 4.3	No visible damage
	Conditions: bending 1 mm at a rate of 1 mm/s,	$\Delta$ C/C: Class I, within ±1% or 0.5 pF, whichever is greater
	radius jig 5mm.	Class II: X7R, X5R:±10%, Y5V: ±20%
Resistance to soldering heat	Precondition:	Dissolution of the end face plating shall not exceed 25%
	150 +0/-10 $^\circ\!\mathrm{C}$ /1 hr, then keep for 24±1 hrs at room temp	of the length of the edge concerned.
	Preheating: for size >1206:100 to 120 °C for 1 minute and	Δ C/C:
	170 to 200°C for 1 minute.	Class I, within $\pm 0.5\%$ or 0.5 pF, whichever is greater
	Solder bath temperature: 260 ± 5°C	Class II: X7R, X5R:±10%, Y5V: ±20%
	Dipping time 10±0.5 s	DF: within initial specified value
	Recovery time 24±2 Hours.	IR: within initial specified value
Solderability	The specimen shall be preheated to a temperature of	The solder should cover over 95% of the critical area
	80 to 140 $^\circ\!\!\!C$ and maintained for 30s to 60s.	of each termination.
	1. Temperature: 235±5°C / Dipping time: 2 ±0.5 s	
	2. Temperature: 245±5°C / Dipping time: 3 ±0.5 s (lead free)	
	Depth of immersion: 10mm	
Rapid change of temperature	Precondition:	No visual damage
	150 +0/-10 $^\circ\!\mathrm{C}$ /1 hr, then keep for 24±1 hrs at room temp	∆ C/C:
	5 cycles with following detail:	Class I, within $\pm 1\%$ or 1 pF, whichever is greater
	30 minutes at Lower Category Temperature;	Class II: X7R, X5R:±15%, Y5V: ±20%
	30 minutes at Upper Category Temperature;	DF: within initial specified value
	Recovery time 24±2 Hours.	IR: within initial specified value
Damp heat with Ur load	1. Precondition (Class II only):	No visual damage after recovery
	150 +0/-10 $^\circ\!\mathrm{C}$ /1 hr, then keep for 24±1 hrs at room temp	Δ C/C:
	2. Initial measure	Class I, within ±2% or 1 pF, whichever is greater
	Spec: refer Initial spec (Cap, DF, IR)	Class II: X7R, X5R:±15%, Y5V: ±30%
	3. Damp heat test:	DF:
	500±12 hours at 40±2°C; 90 to 95% R.H.; 1.0Ur applied	Class I: 2 x specified value
	4. Recovery:	Class II:
	Class 1 : 6 to 24 hours, Class 2 : 24±2 hours	X7R/X5R:
	5. Final measure:	$\leq$ 16V : $\leq$ 7% or 2 x specified value whichever is greater
	Cap, DF, IR	$\geq\!25V$ : $\leq\!5\%$ or 2 x specified value whichever is greater
		Y5V: ≤15%
	P.S. If the capacitance value is less than the minimum value	IR:
	permitted, then after the other measurements have been made	e Class I:
	the capacitor shall be precondition according to IEC 60384 4.1	${\geq}2{,}500M\Omega$ or RxC ${\geq}25\Omega{.}F$ whichever is less
	and then the requirement shall be met.	Class II:
		$\geq$ 500M $\Omega$ or RxC $\geq$ 25 $\Omega$ .F whichever is less



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Endurance	1. Precondition (Class II only):	No visual damage after recovery
	150 +0/-10 $^\circ\!\mathrm{C}/1$ hr, then keep for 24±1 hrs at room temp	∆ C/C:
	2. Initial measure	Class I, within ±2% or 1 pF, whichever is greater
	Spec: refer Initial spec (Cap, DF, IR)	Class II: X7R, X5R:±15%, Y5V: ±30%
	3. Endurance test:	DF:
	Temperature: NPO/X7R: 125 $^\circ\!\!{\rm C}$ , X5R/Y5V: 85 $^\circ\!\!{\rm C}$	Class I: 2 x specified value
	Specified voltage applied for 1000 hrs	Class II:
	Applied 200% Ur for 4V to 100V series	X7R/X5R:
	Applied 150% Ur for 200V/250V series	$\leq$ 16V : $\leq$ 7% or 2 x specified value whichever is greater
	Applied 130% Ur for 500V/630V series	$\geq$ 25V : $\leq$ 5% or 2 x specified value whichever is greater
	Applied 120% Ur for 1000V and above series	Y5V: ≤15%
	Recovery time: 24±2 hours	
	5. Final measure:	IR:
	Cap, DF, IR	Class I:
		${\geq}4,000 M\Omega$ or RxC ${\geq}40 \Omega.F$ whichever is less
	P.S. If the capacitance value is less than the minimum value	Class II:
	permitted, then after the other measurements have been made	$\geq$ 1000M $\Omega$ or RxC $\geq$ 50 $\Omega$ .F whichever is less
	the capacitor shall be precondition according to IEC 60384 4.1	
	and then the requirement shall be met.	
Voltage Proof	Specified stress voltage applied for 1 ~5 sec.	No breakdown or flashover
	Ur = 100 V: series applied 2.5 Ur	
	100 V < Ur $\leq$ 200 V series applied (1.5 Ur + 100)	
	200 V < Ur $\leq$ 500 V series applied (1.3 Ur + 100)	
	Ur = 630 V: 1.3 Ur	
	Ur ≥ 1000 V: 1.2 Ur	
	Charge / Discharge current less than 50mA.	

### Shelf Life & Storage Condition

According with international specification JIS 1997.(1) Storage Condtions:Temperature -5 to 40°C<br/>Relative humidity 40~60%(2) Shelf Life:2 years from date of manufacture

We recommend that the products are stored in their original packing (e.g. tape, reel). They should never be touched by hand.



# **Soldering Condition**

For normal use the capacitors may be mounted on printed-circuit boards or ceramic substrates by applying wave soldering, reflow soldering or conductive adhesive in accordance with "IEC 61760-1" (Standard method for the specification of surface mounting components).



Dotted lines: Process limits - bottom process limit (terminal temperature) & upper process limit (top surface temperature).

Infrared soldering, forced gas convection reflow soldering - Temperature/time profile for SnPb solders



Infrared soldering, forced gas convection reflow soldering - Temperature/time profile for lead-free SnAgCu solders





Double wave soldering for SnPb and lead-free SnAgCu solder - Temperature/time profile (terminal temperature)